



## Material Content Data Sheet



Halogen-Free

<b>Sales Product Name</b>	BTS441RG	<b>Issued</b>	03. May 2021
<b>MA#</b>	MA000919976		
<b>Package</b>	PG-TO263-5-2	<b>Weight*</b>	1549.18 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	8.276	0.53	0.53	5342	5342
leadframe	inorganic material	phosphorus	7723-14-0	0.237	0.02		153	
	non noble metal	iron	7439-89-6	0.790	0.05		510	
	non noble metal	copper	7440-50-8	788.527	50.90	50.97	508996	509659
wire	non noble metal	aluminium	7429-90-5	4.223	0.27	0.27	2726	2726
encapsulation	organic material	carbon black	1333-86-4	1.239	0.08		800	
	plastics	epoxy resin	-	57.000	3.68		36794	
	inorganic material	silicon dioxide	60676-86-0	561.329	36.23	39.99	362338	399932
leadfinish	non noble metal	tin	7440-31-5	10.339	0.67	0.67	6674	6674
plating	inorganic material	phosphorus	7723-14-0	0.008			5	
	non noble metal	nickel	7440-02-0	3.422	0.22	0.22	2209	2214
solder	non noble metal	tin	7440-31-5	0.114	0.01		74	
	noble metal	silver	7440-22-4	0.143	0.01		92	
	non noble metal	lead	7439-92-1	5.452	0.35	0.37	3519	3685
heatspreader	inorganic material	phosphorus	7723-14-0	0.032			21	
	non noble metal	iron	7439-89-6	0.108	0.01		70	
	non noble metal	copper	7440-50-8	107.943	6.97	6.98	69677	69768
*deviation	< 10%	Sum in total:				100.00		1000000

### Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

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